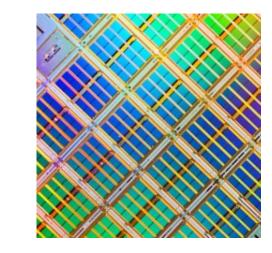
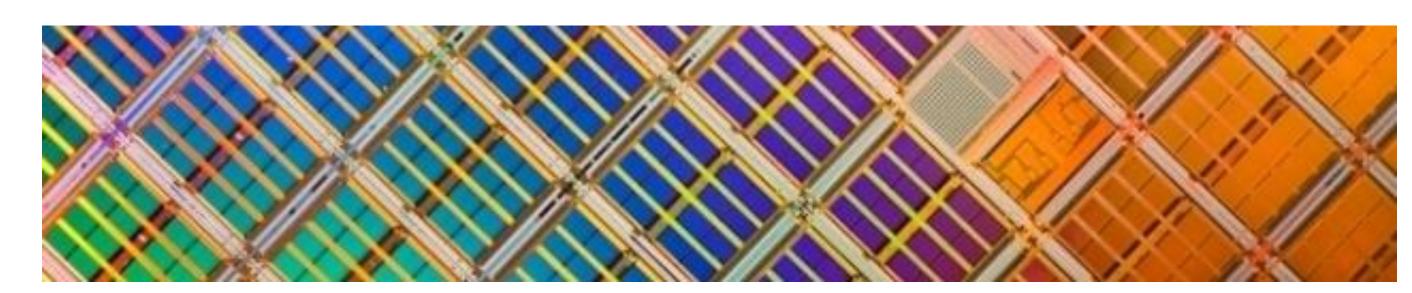
S.C.E. Partners

Client Driven. Client Lead.





Investment Banking for Semiconductors, IT & Electronics Supply

Semiconductor Industry Coverage Landscape
July 2020

SEMICONDUCTORS & EQUIPMENT LANDSCAPE 2020







DSP















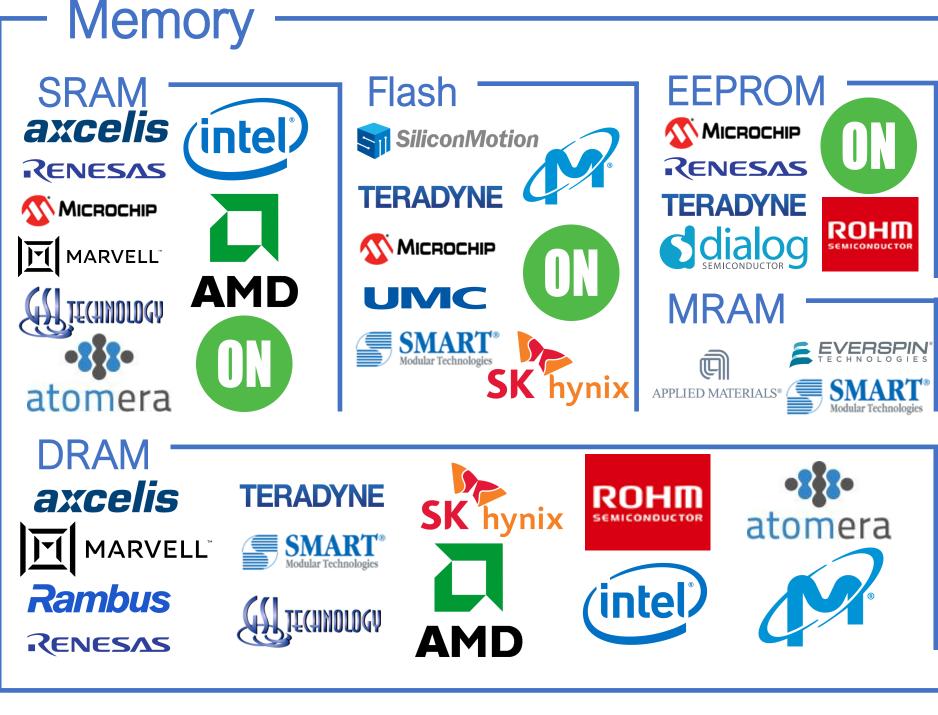


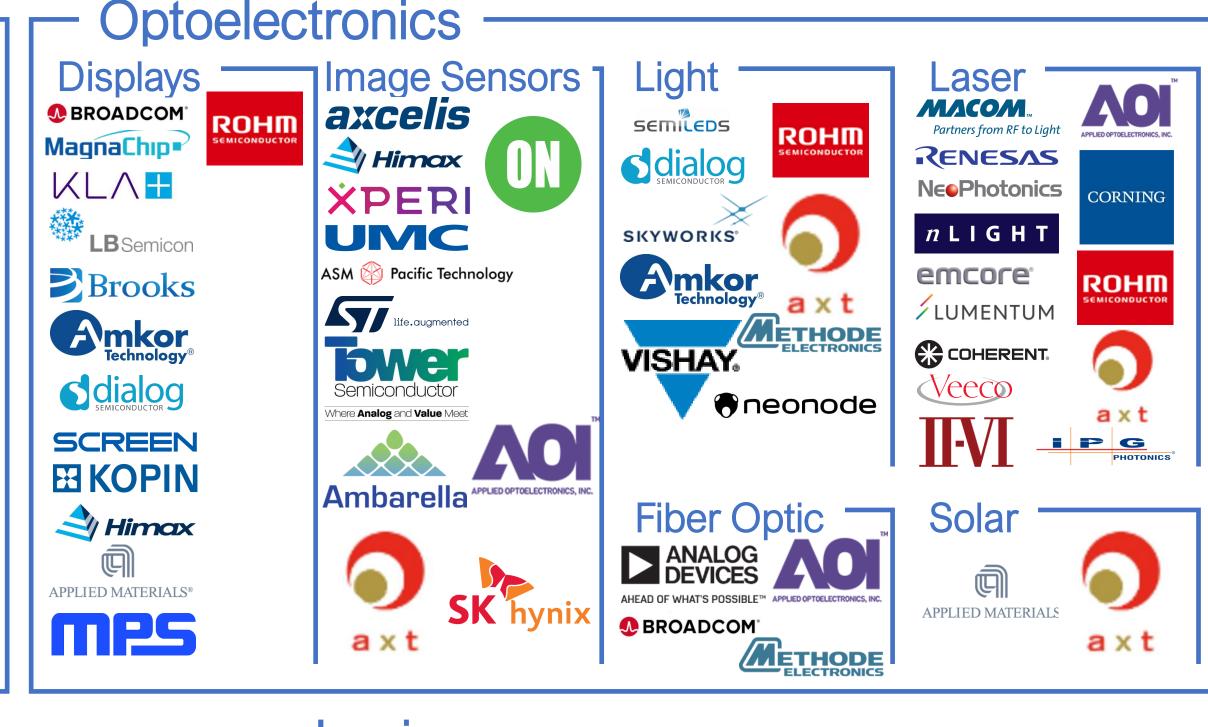
SATS

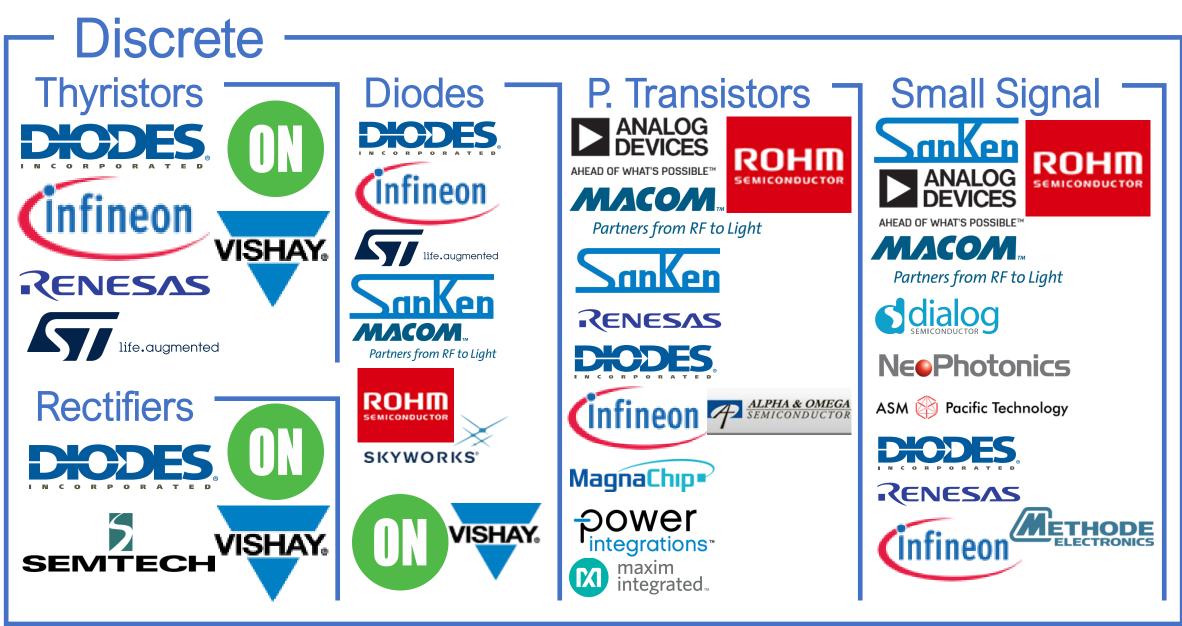


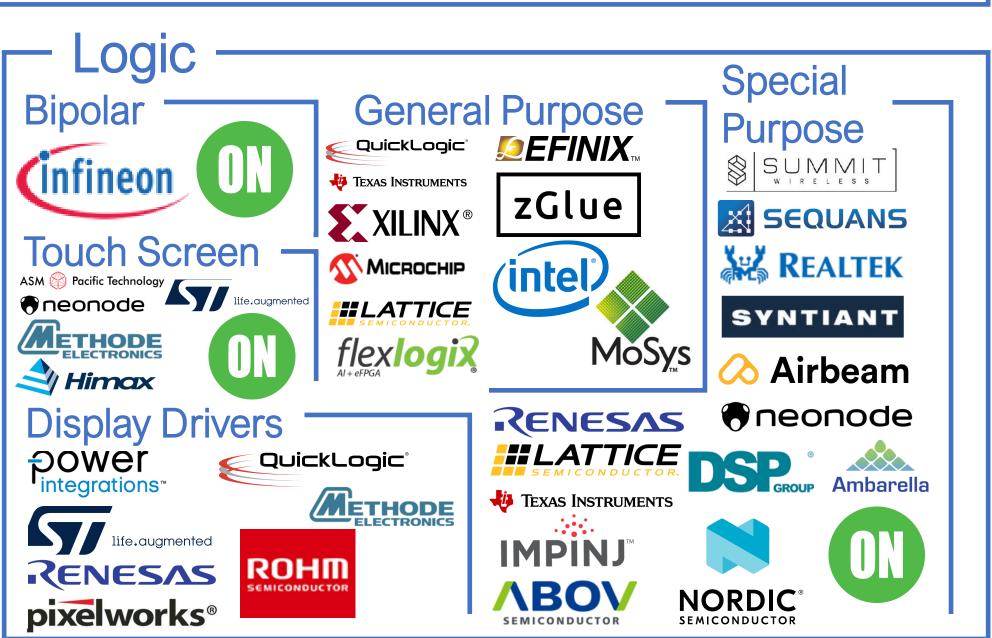


SEMTECH atomera









METHODE

RENESAS

KEYSIGHT TECHNOLOGIES

APPLICATION SPECIFIC INTEGRATED CIRCUITS

Application specific integrated circuits (ASICs) are related to, but not limited to, consumer, computer and peripherals, wireless communication, wired communication, automotive infotainment, other automotive, IC card, and multipurpose. They include all application specific ICs not outlined in other semiconductor segments.























SENSORS & ACTUATORS

Sensors and Actuators are semiconductor devices whose electrical properties are designed to correlate to temperature, pressure, displacement, velocity, acceleration, stress, strain or any other physical, chemical or biological property.





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SEMICONDUCTOR EQUIPMENT

SATS include semiconductor Testing, Measurement, and Assembly operations in Semiconductor Equipment Manufacturing. These functions include Lithography, Metrology, Etching, and Casting.







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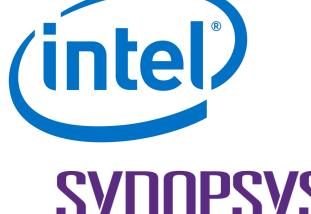




Electronic Design Automation (EDA) are software tools for designing electronic systems such as integrated circuits and printed circuit boards. The tools work together in a design flow that chip designers use to design and analyze entire semiconductor chips.















PDF/SOLUTIONS"











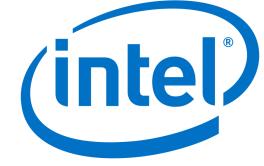
Intellectual Property (IP) is a reusable unit of logic, cell, or integrated circuit layout design.

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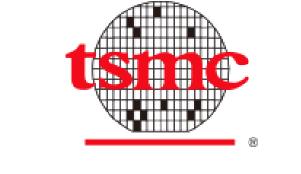












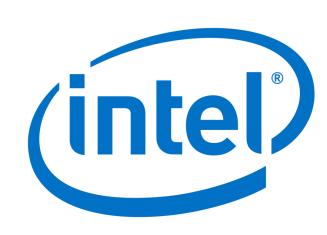


MOS MICRO

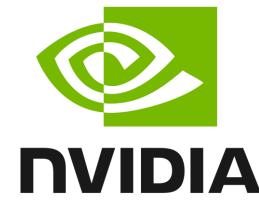
The microprocessor (MPU) category includes ICs which execute external instructions and perform system control functions as programmed via software with the assembly language instructions retrieved from external memory with data read from and written to external RAM devices to perform system functions. These include CISC, RISC, CPUs, and GPUs.



















Microcontrollers (MCUs) perform dedicated or embedded computer functions within an overall electronic system without the need of other support circuits. They contain some form of ROM, EPROM or Flash Memory, and also incorporates read-write memory (RAM) for temporary storage.































Digital Signal Processors (DSPs) use parallel multipliers with separate program and data areas (Harvard type architecture), which provide very high-speed performance required in "Sum-of-Product" operations.











ANALOG INTEGRATED CIRCUITS

Amplifiers & Comparators condition or modify the incoming analog signal to enhance it for further processing such as signal conversion or interfacing. This category includes devices which provide functions such as signal filtering, signal amplification, level shifting, buffering or comparison.

































Signal Conversion's role is to convert the signal from one form to another including digital ICs such as an MPU or FPGA. The signal before or after conversion should be analog.



































Interface's function is to modify or shape the signal in order to ensure signal integrity for transmission over a distance through a physical medium such as a wire, cable, waveguide, or tracks within a printed circuit board.























intel







MAXLINEAR

















Himax (infineon



















Application Specific includes any analog IC that is not part of the general-purpose lineup.













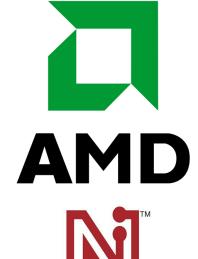




MIRATA NVE

MEMORY

Dynamic Random Access Memory (DRAM) devices allow bit words to be written, stored and read randomly in any desired sequence. The memory information is volatile and is lost when the power supply voltage is removed.











































four transistor memory cell which is configured into a flip-flop circuit.









Electrically Erasable Programmable Read Only Memory (EEPROM) devices are non-volatile circuits with the memory data pattern programmed by electrical means rather than a fixed mask.

Static Random Access Memory (SRAM) devices are based on a minimum











TERADYNE

Flash memory is a type of EEPROM in which the memory data is electrically erased by large arrays of bits rather than by fractions such as bit by bit.



























Magnetoresistive Random Access Memory (MRAM) devices are non-volatile circuits in which data is stored in magnetic domains using electron spin.







OPTOELECTRONICS

Displays are single or multiple digit character displays reported as complete assemblies.





























Lasers are devices generating coherent radiation mainly used for optical disk drives and optical communications.



























Image Sensors are monolithic ICs capable of translating light into electrical voltages or currents for generating an image. These include circular and linear types using device structures such as CCD, CID, CCP, CPD, MOS, CMOS, and SSP.

































Light Sensors are monolithic and assembled modules that detect presence of light and change it into electrical voltages or currents. Such devices include discrete and combo sensors, such as ALS, Proximity, RGB, Ultraviolet, and Heart Rate Sensors.



















Fiber Optic encompasses both the sensing element ("intrinsic sensors"), and a means of relaying signals from a remote sensor to the electronics that process the signals ("extrinsic sensors").

































DISCRETE

Diodes include general-purpose signal and switching, Zener, transient protection, and RF & microwave diodes.



























Small Signal & Switching Transistors have a power dissipation of less than 1W, including all RF and microwave small signal, dual, FET, and all general purpose bipolar small signal transistors.

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Power Transistors have a power dissipation of more than 1W, including RF and microwave, bipolar, FET, IGBT, Darlington, and multiple chip devices.



























Rectifiers include all discrete rectifiers (rated at 0.5 AMPS average or greater) and assemblies/modules composed thereof.













Thyristors include all unidirectional and bi-directional thyristors and assemblies/modules composed primarily thereof.



















LOGIC

Digital Bipolar includes all digital logic and memory product that is made with bipolar integrated circuitry technology (TTL, ECL, DTL, IIL, RTL).





General Purpose devices are standard commodity catalog products, usually simple gates, flip-flop circuits, and registers. Some examples include FPGA, PLD, and PAL.





















Display Drivers: Devices specifically designed to control and drive flat panel displays such as LCDs and PDPs.

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Touch Screen Controllers accompany touch screen displays and are capable of determining the location of single or multi-touch gestures, styli and gloves, using capacitive, resistive or other sensing technologies.

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Special Purpose devices are either ASSPs designed by semiconductor manufacturer or CSICs designed by the customer.





































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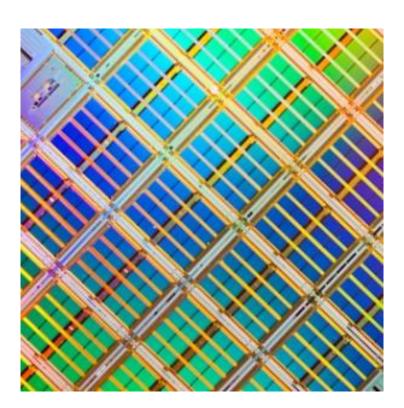
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